



# THERMOSET TOPCON

WORLD'S LEADING THERMOSET TECHNOLOGY CONFERENCE & EXPO

Presented by SPE Thermoset Division

May 12 – 13, 2026 at the Monona Terrace in Madison, Wisconsin

## SPONSOR AND/OR EXHIBIT & PRESENT AT – THE FUTURE OF THERMOSETS: AI AND EMERGING INDUSTRY INNOVATIONS



Advancements in AI are speeding developments in all industries and this year's event will feature keynotes and presentations on how the thermoset industry can benefit from this growing technology. Innovations in Materials, Additives, Molding, Testing, Applications, Business, Sustainability and More will also be featured. Abstracts due by February 17, 2026. Final Presentations due April 17, 2026. Please reach out ASAP as Limited Presentation and Exhibit spaces are available. Send Abstracts and Sponsorship and Exhibit inquiries to Teri Chouinard at [Intuitgroup@gmail.com](mailto:Intuitgroup@gmail.com) or call 248.701.8003, and [Sean.Campbell@LYB.com](mailto:Sean.Campbell@LYB.com) or call 615.561.4234 and go to <https://spethermosets.org/topcon/>.

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